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AMENDMENTS TO THE CLAIMS:

This listing of claims will replace all prior versions, and listings, of claims in the application:

LISTING OF CLAIMS:

Claims 1-6 (canceled).

Claim 7 (previously presented): A piezoelectric oscillator unit comprising:
a circuit substrate including a cavity provided therein and a wall provided around the cavity, the wall having a top surface with electrodes disposed thereon, the circuit substrate having an oscillatory circuit mounted in the cavity thereof;
a vibrator package overlaid on said circuit substrate, said vibrator package housing a piezoelectric member therein and said vibrator package having electrodes provided on the bottom surface thereof which are bonded to said electrodes provided on the top surface of the wall of said circuit substrate; and
an adhesive arranged between the top surface of said wall of the circuit substrate and the bottom surface of said vibrator package to bond said circuit substrate and said vibrator package together; wherein
the circuit substrate is defined by a multilayer ceramic substrate, and the cavity is disposed at the approximate center thereof to mount components; and
a transistor for oscillation and buffer amplification, a varicap diode, a multilayer capacitor, a chip thermistor for temperature compensation, and a chip resistor are surface-mounted within said cavity.

Claim 8 (previously presented): A piezoelectric oscillator unit comprising:
a circuit substrate including a cavity provided therein and a wall provided around the cavity, the wall having a top surface with electrodes disposed thereon, the circuit

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substrate having an oscillatory circuit mounted in the cavity thereof;

a vibrator package overlaid on said circuit substrate, said vibrator package housing a piezoelectric member therein and said vibrator package having electrodes provided on the bottom surface thereof which are bonded to said electrodes provided on the top surface of the wall of said circuit substrate;

an adhesive arranged between the top surface of said wall of the circuit substrate and the bottom surface of said vibrator package to bond said circuit substrate and said vibrator package together;

a case arranged to receive said vibrator package; and

a shielding plate arranged on said case to hermetically seal said vibrator package.

Claim 9 (previously presented): A piezoelectric oscillator unit comprising:

a circuit substrate including a cavity provided therein and a wall provided around the cavity, the wall having a top surface with electrodes disposed thereon, the circuit substrate having an oscillatory circuit mounted in the cavity thereof;

a vibrator package overlaid on said circuit substrate, said vibrator package housing a piezoelectric member therein and said vibrator package having electrodes provided on the bottom surface thereof which are bonded to said electrodes provided on the top surface of the wall of said circuit substrate; and

an adhesive arranged between the top surface of said wall of the circuit substrate and the bottom surface of said vibrator package to bond said circuit substrate and said vibrator package together; wherein

said circuit substrate includes via holes arranged to connect said electrodes provided on the bottom surface of said circuit substrate to said electrodes provided on said top surface of said circuit substrate wall.

Claim 10 (canceled)

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Claim 11 (previously presented): A piezoelectric oscillator unit comprising:
a circuit substrate having an oscillatory circuit mounted thereon;
a vibrator package overlaid on said circuit substrate, said vibrator package housing a piezoelectric member therein and said vibrator package having electrodes provided on the bottom surface thereof which are bonded to electrodes provided on the top surface of said circuit substrate;
a shielding case covering said vibrator package so that said shielding case contains said vibrator package; and
an adhesive arranged to adhere said shielding case to said circuit substrate;
wherein said shielding case is provided with protrusions, said circuit substrate is provided with holes, each of said protrusions is inserted into a corresponding one of said holes, and said protrusions are fixed in said holes by said adhesive which is filled in said holes.

Claim 12 (canceled)

Claim 13 (original): A piezoelectric oscillator unit according to Claim 11, wherein said adhesive is a thermosetting adhesive.

Claims 14 and 15 (canceled)

Claim 16 (original): A piezoelectric oscillator unit according to Claim 11, wherein said protrusions of said shielding case are claws.

Claims 17 and 18 (canceled)

Claim 19 (previously presented): A piezoelectric oscillator unit comprising:

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a circuit substrate having an oscillatory circuit mounted thereon;
a vibrator package overlaid on said circuit substrate, said vibrator package housing a piezoelectric member therein and said vibrator package having electrodes provided on the bottom surface thereof which are bonded to electrodes provided on the top surface of said circuit substrate;
a shielding case covering said vibrator package so that said shielding case contains said vibrator package; and
an adhesive arranged to adhere said shielding case to said circuit substrate;
wherein the circuit substrate is defined by a multilayer ceramic substrate, and includes a cavity disposed at the approximate center thereof to mount components;
said multilayer ceramic substrate includes a wall provided around the cavity;
and
said electrodes are provided at four corners of the top surface of the wall, and external electrodes are provided at four corners of the bottom surface of the wall.